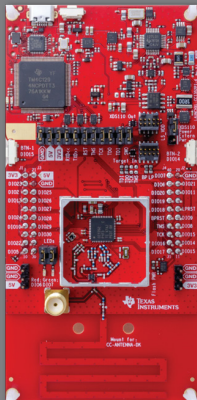




## TI LaunchPad™ kit with SimpleLink™ Wireless MCU

Microcontroller development kit for rapid prototyping  
featuring the CC1352P microcontroller

PART NO: LAUNCHXL-CC1352P1



LAUNCH  
YOUR DESIGN

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[dev.ti.com/launchxl-cc1352p1](http://dev.ti.com/launchxl-cc1352p1)

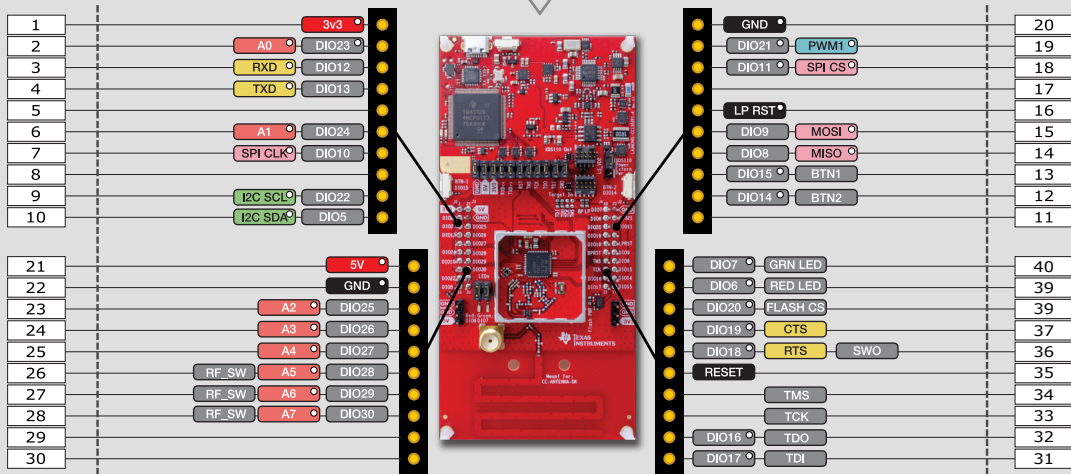


# TI LaunchPad™ kit with SimpleLink™ Wireless MCU

Microcontroller development kit for rapid prototyping featuring the CC1352P microcontroller

PART NO: LAUNCHXL-CC1352P1

○ Pin aligns with LaunchPad pinout standard.



Explore all TI LaunchPad™ kits @ [www.ti.com/launchpad](http://www.ti.com/launchpad)

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